

SPECIFICATION

Electrical :

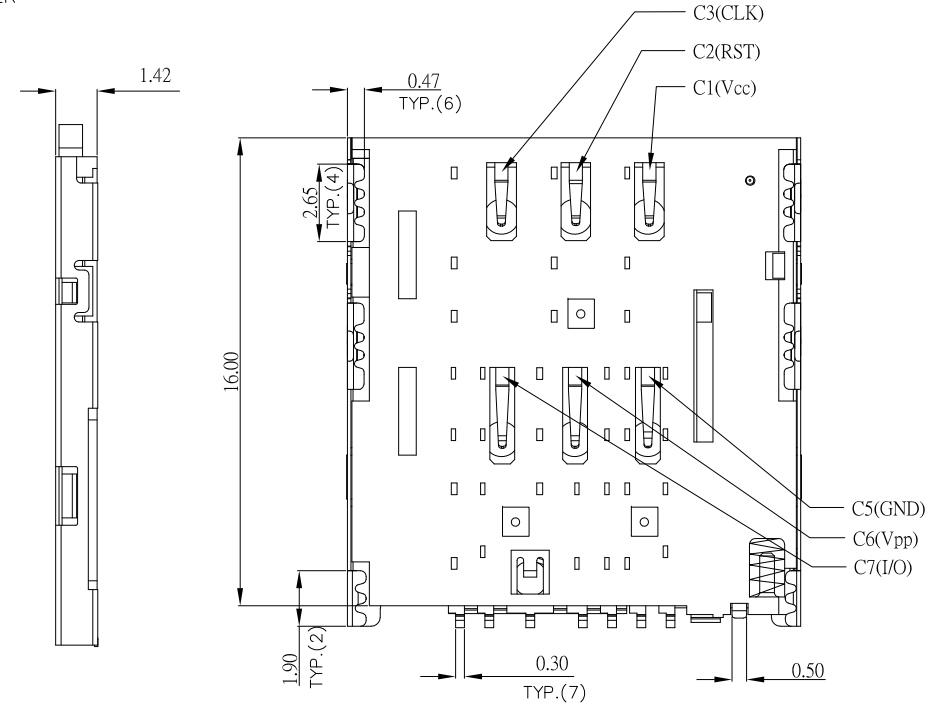
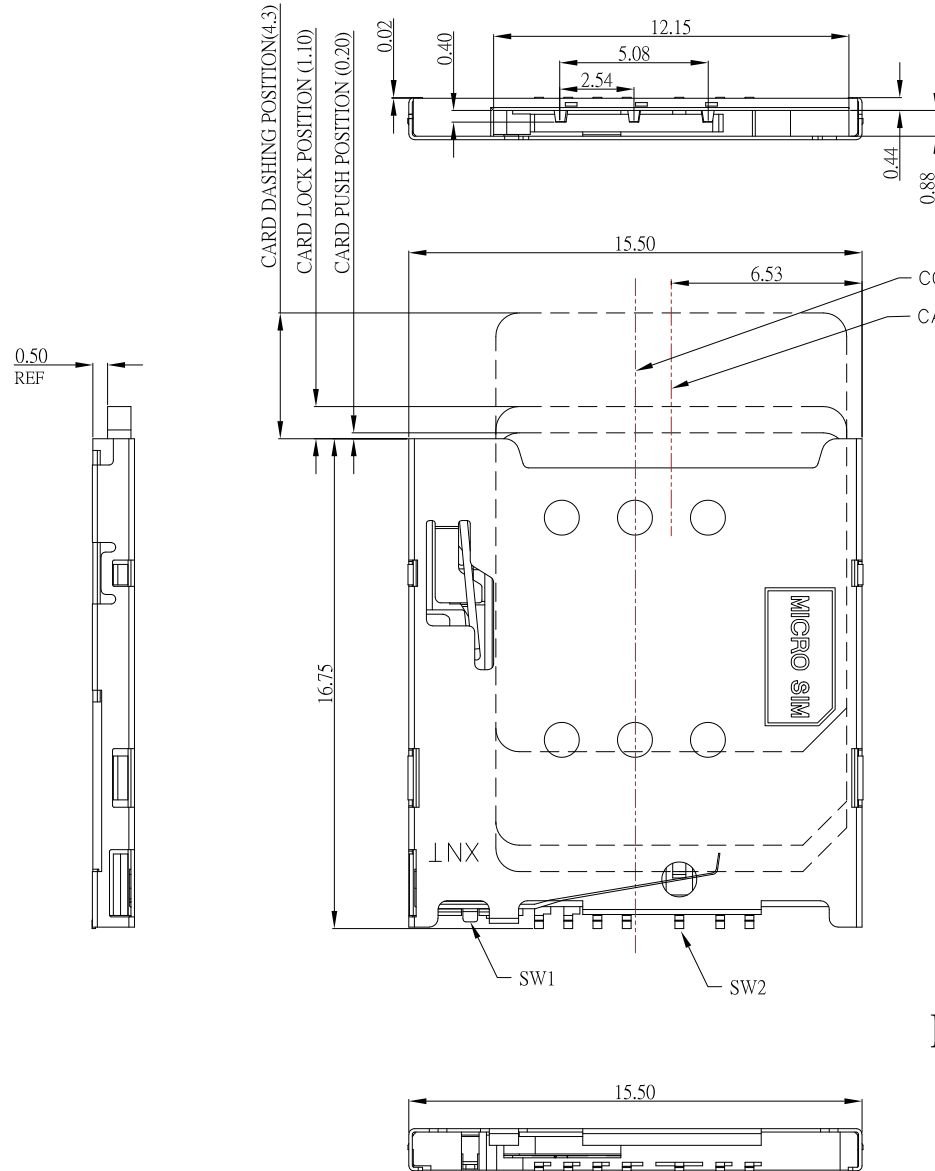
- 1.Current Rating: 0.5A
- 2.Voltage Rating: 5V AC/DC
- 3.Contact Resistance: 100 mΩ Max.
- 4.Insulation Resistance: 1000 MΩ Min.

Environmental:

- 1.Operating Temperature: -40°C ~ +85°C.

Material:

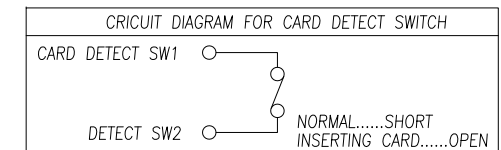
- 1.Housing: LCP
 - 2.Contact: Phosphor Bronze
 - 3.Shell: Stainless Steel
- Finish:
- 1.Contact: Plated Gold in Mating Area ;
Tin Plated on Solder Balls ;
Nickel under plated overall
 - 2.Shell: Nickel under Plated surface layer



MSIM-0271G06-x-S267

鍍層厚度 :

Blank : G/F
3 : 30u"



5	新增開關標示	Jack	082124
4	更新材質	Jack	062123
3	更新底部樣式	Neo	042922
2	更新底部樣式	Jack	080519
1	新增鍍層選項	Jack	032819
ITEM NO.	DESCRIPTION	DRAWN	DATE

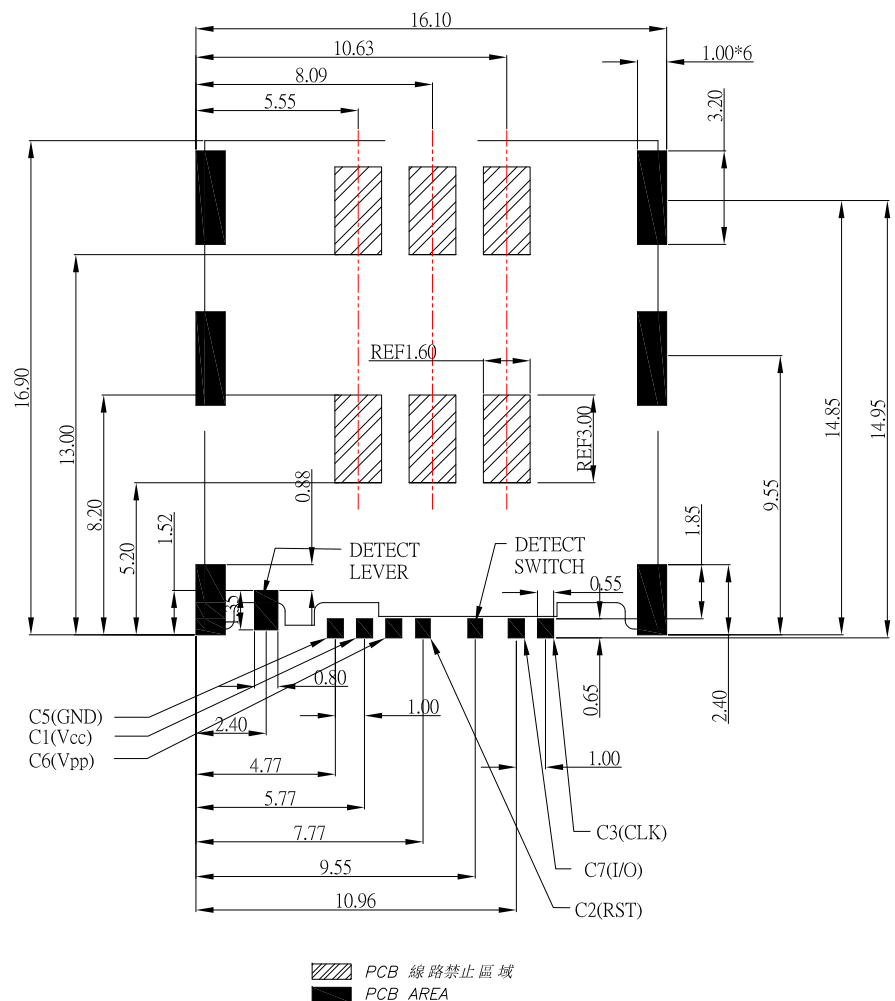
CONTACT 建倚科技股份有限公司
CONTACT TECHNOLOGY CORP.

TOLERANCE UNLESS OTHERWISE STATED :
Up to 5 ±0.2
Above 5 ~ 15 ±0.3
Above 15 ~ 30 ±0.4
Above 30 ~ 50 ±0.5
Angle ±0.3°

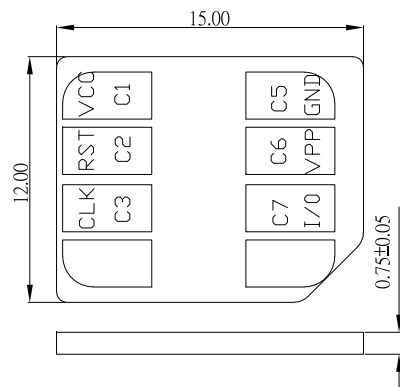
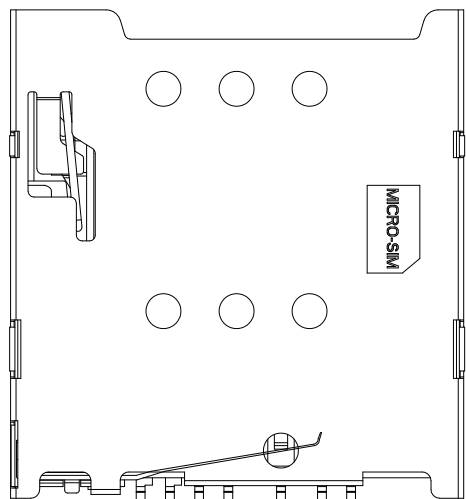
3RD. ANGEL'S

UNITS MM

DRAWN BY:	DATE	MAT'L	TITLE	CONNECTOR
Jack Lu	08/21/24	FINISH	MODLE	MICRO SIM PUSH. H142 防呆型
CHECKED BY:	DATE	SCALE	DWG NO.	MSIM-0271G06-x-S267
Jacky Chen	08/21/24	1 : 1	MSIM-0271G06-x-S267	SIZE A4
APPROVED BY:	DATE	SHEET NO.	PART NO.	VER
Tony Kao	08/21/24	1 of 2	MSIM-0271G06-x-S267	R5



RECOMMENDED PCB LAYOUT



MICRO SIM CARD

5	新增開關段標示	Jack	082124
4	更新材質	Jack	062123
3	更新底部樣式	Neo	042922
2	更新底部樣式	Jack	080519
1	新增鍍層選項	Jack	032819
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Jacky Chen	08/21/24	1 : 1	PART NO.	MSIM-0271G06-x-S267
APPROVED BY:	DATE	SHEET NO.	2 of 2	VER R5
Tony Kao	08/21/24			